Kingbright

APFA3010LSEKJ3ZGKQBC

3.0 x 1.0 mm Right Angle SMD Chip LED Lamp

DESCRIPTIONS

- The Hyper Red device is based on light emitting diode chip made from AlGaInP
- The Green source color devices are made with InGaN on Sapphire Light Emitting Diode
- The Blue source color devices are made with InGaN Light Emitting Diode
- · Electrostatic discharge and power surge could damage the LEDs
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- · All devices, equipments and machineries must be electrically grounded

FEATURES

- 3.0 x 1.5 x 1.0 mm right angle SMD LED, 1.0 mm thickness
- · Low power consumption
- · Wide viewing angle
- · Ideal for backlight and indicator
- Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- · Tinned pads for improved solderability
- Halogen-free
- · RoHS compliant

APPLICATIONS

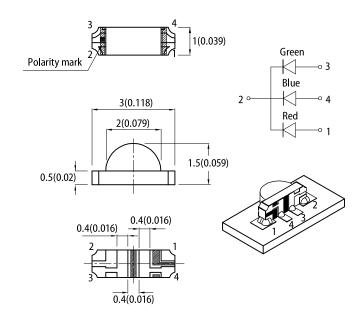
- Backlight
- · Status indicator
- · Home and smart appliances
- · Wearable and portable devices
- · Healthcare applications

ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices

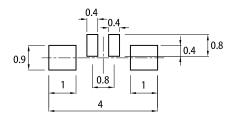


PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN

(units: mm; tolerance: ± 0.1)



- . All dimensions are in millimeters (inches). . Tolerance is ±0.2(0.008") unless otherwise noted.

- 2. Tolerance is ±0.2(0.008") unless otherwise noted.
 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 4. The device has a single mounting surface. The device must be mounted according to the specifications.
 5. For right angle SMD LEDs, the solder stencil should be at least 5mil in thickness, to prevent poor solder wetting due to insufficient solder paste.

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	Iv (mcd) @ 2mA [2]		Viewing Angle [1]	
			Min.	Тур.	201/2	
APFA3010LSEKJ3ZGKQBC	Hyper Red (AlGalnP)	Water Clear	20	40		
	Green (InGaN)		20	60	150°	
	■ Blue (InGaN)		4	10		

Notes.

1. 61/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

2. Luminous intensity / luminous flux: +/-15%.

3. Luminous intensity value is traceable to CIE127-2007 standards.





ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Counch of	Fueltting Colon	Value		1114	
Parameter	Symbol	Emitting Color	Тур.	Max.	Unit	
Wavelength at Peak Emission I _F = 2mA	λ_{peak}	Hyper Red λ _{peak} Green Blue		-	nm	
Dominant Wavelength I _F = 2mA	λ_{dom} [1]	Hyper Red Green Blue	625 525 465	-	nm	
Spectral Bandwidth at 50% Φ REL MAX I _F = 2mA	Δλ	Hyper Red Green Blue	20 35 25	-	nm	
Capacitance	С	Hyper Red Green Blue	27 45 100	-	pF	
Forward Voltage I _F = 2mA	V _F ^[2]	Hyper Red Green Blue	1.8 2.65 2.65	2.1 3.1 3.1	V	
Reverse Current (V _R = 5V)	I _R	Hyper Red Green Blue	-	10 50 50	μА	
Temperature Coefficient of λ_{peak} I _F = 2mA, -10°C \leq T \leq 85°C	TC_{\lambdapeak}	Hyper Red Green Blue	0.13 0.05 0.04	-	nm/°C	
Temperature Coefficient of λ_{dom} I _F = 2mA, -10°C \leq T \leq 85°C	TC_{\lambdadom}	Hyper Red Green Blue	0.06 0.03 0.03	-	nm/°C	
Temperature Coefficient of V_F I_F = 2mA, -10°C \leq T \leq 85°C	TC _V	Hyper Red Green Blue	-2.0 -3.0 -3.0	-	mV/°C	

Notes.

1. The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd: ±1nm.)

2. Forward voltage: ±0.1V.

3. Wavelength value is traceable to CIE127-2007 standards.

4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

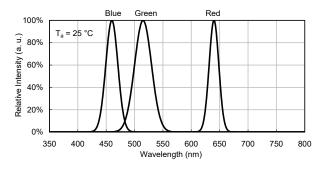
Parameter	Symbol	Value			1114
Parameter		Hyper Red	Green	Blue	Unit
Power Dissipation	P _D ^[1]	84	102.5	120	mW
Reverse Voltage	V_R	5	5	5	V
Junction Temperature	T _j	115	115	115	°C
Operating Temperature	T _{op}	-40 to +85			°C
Storage Temperature	T _{stg}	-40 to +85			°C
DC Forward Current	I _F ^[1]	30	25	30	mA
Peak Forward Current	I _{FM} ^[2]	150	150	150	mA
Electrostatic Discharge Threshold (HBM)	-	3000	450	250	V
Thermal Resistance (Junction / Ambient)	R _{th JA} ^[2]	360	570	630	°C/W
Thermal Resistance (Junction / Solder point)	R _{th JS} ^[2]	260	460	520	°C/W

Notes:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. R_{n, M}, R_{th S} Results from mounting on PC board FR4 (pad size ≥ 16 mm² per pad).
3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

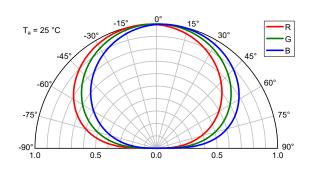


TECHNICAL DATA

RELATIVE INTENSITY vs. WAVELENGTH

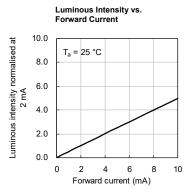


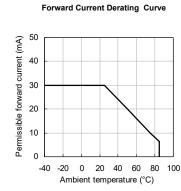
SPATIAL DISTRIBUTION

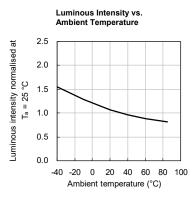


HYPER RED

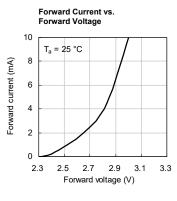
Forward Current vs. Forward Voltage 10 T_a = 25 °C 8 Forward current (mA) 6 2 n 1.9 2.0 Forward voltage (V)

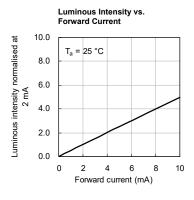


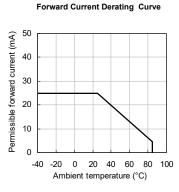


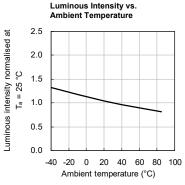


GREEN

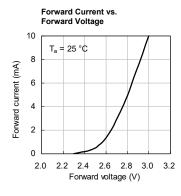


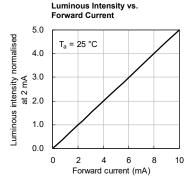


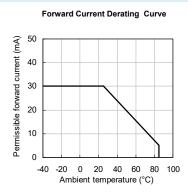


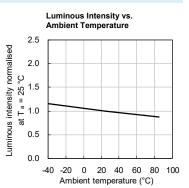


BLUE









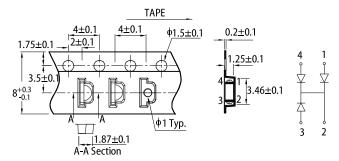


REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

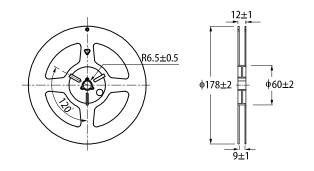
300 above 255°C (°C) 260°C max. 30s max. 10s max. 250 3°C/s max 6°C/s max. 200 150 Temperature pre-heating 100 150~200°C above 217°C 60~120s 50 . 25℃ 0 50 100 150 200 250 300 (sec) Time

- 1. Don't cause stress to the LEDs while it is exposed to high temperature.
 2. The maximum number of reflow soldering passes is 2 times.
 3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

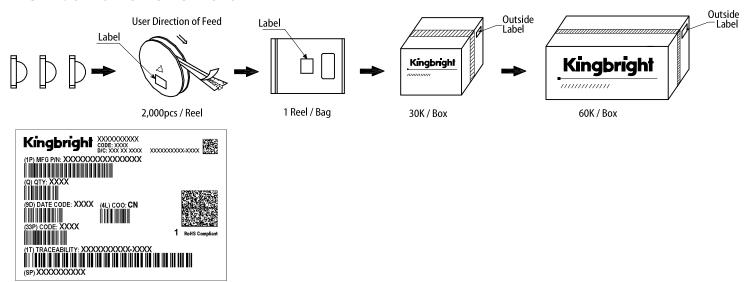
TAPE SPECIFICATIONS (units:mm)



REEL DIMENSION (units: mm)



PACKING & LABEL SPECIFICATIONS



PRECAUTIONARY NOTES

- The information included in this document reflects representative usage scenarios and is intended for technical reference only
- The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.

 The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening
- liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.

 The contents and information of this document may not be reproduced or re-transmitted without permission by Kingbright.
- All design applications should refer to Kingbright application notes available at https://www.Kingbright

